

Future Electronics

Date August 27, 2019



Doc. No.: 301800F

Toshio Nakajima
 Division Manager
 Power Transistor Div.
 ROHM Co., Ltd.

Product/Process Change Notification

Dear Customer,
 This is an announcement of change(s) to the process being used for the products currently supplied.
 We request your acknowledgement to receive this notification within the given period.

Please reply by: September 14, 2019

Title of change	The additional approval of ROHM Shiga factory for automotive MOSFET products.					
Affected product(s)	Product name	Customer part number				
	RTR025P02FRATL RSR030N06MGTL RSR030N06MGTL	RTR025P02FRATL RSR030N06MGTL RSR030N06MGTL				
Detailed description of change	Now	After				
	Made by ROHM Apollo Chikugo	Made by ROHM Apollo Chikugo or ROHM Shiga				
Reason for change	Improvement of L/T with the production Capa up. And I add a production factory and plan risk dispersion to be able to do a stable mass production in the emergency.					
Anticipated impact on quality	The characteristic is equal and does not have effect to quality.					
Identification of change	Because there is not mention of the production factory, the identification from the appearance becomes impossible. But the identification at the time of the abnormality is possible because I classify an identification pattern into Chip in itself.					
Planned date of change	October 1, 2019	Sample availale schedule	October 3, 2018			
Attachments (data, report)	Yes <input checked="" type="radio"/> No					
Comments	-					
Reply to	Name	Masayuki Nishiyama	Title	Engineer	E-mail	masayuki.nishiyama@mnf.rohm.co.jp
	Department	WP development Div.		Tel	-	
		Reply date				
Customer reply	<input type="checkbox"/> 1. Approved. <input type="checkbox"/> 2. Accepted with conditions. <input type="checkbox"/> 3. Rejected.					
Condition for approval / reason for rejection						
Comments						
Customer company name						
Customer signature				Department		
Customer signature				Department		